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To the Honorable Commissioner of Patents

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Original documents or copy thereof.

1. Name of conveying party(ies): Sheng-Yuan Lee

2. Name and address of receiving party(ies) Name: VIA Technologies, Inc. of R.O.C.

Additional name(s) of conveying party(ies) attached? [ ] Yes [x] No

Internal Address:

3. Nature of conveyance:

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Street Address: 8F, 535 Chung-Cheng Road Hsin-Tien

Execution Date: 02/01/2005

City: Taipei, Taiwan State: Zip: ROC 231

Additional name(s) & address(es) attached? [ ] Yes [x] No

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: 02/01/05

A. Patent Application No.(s) 11/050,385

B. Patent No.(s)

Additional numbers attached? [ ] Yes [x] No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Howard Chen, Esq.

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41).....\$ 40.00

Internal Address:

- [x] Enclosed [x] Authorized to be charged to deposit account

Preston Gates & Ellis LLP

8. Deposit account number:

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9. Signature.

Howard Chen, Reg. No. 46,615 Name of Person Signing

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7/27/05 Date

Total number of pages including cover sheet, attachments, and documents: 3

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## ASSIGNMENT AND AGREEMENT

For value received, I/we, **Sheng-Yuan Lee**, hereby sell, assign and transfer to **VIA Technologies, Inc. of Taiwan, R.O.C.** with its principal place of business located at 8F, 535 Chung-Cheng Road, Hsin-Tien, Taipei 231, Taiwan R.O.C., and its successors, assigns and legal representatives, the entire right, title and interest, for the United States of America, in and to certain inventions related to **A SKEW-SYMMETRICAL DEFECTED GROUND STRUCTURE FOR PARALLEL-COUPLED LINE FILTERS** described in an application for Letters Patent of the United States executed on even date herewith, and all the rights and privileges in said application and under any and all Letters Patent and any divisions, continuations, continuations-in-part, reexamination certificates, reissues, and extensions thereof that may be granted in the United States for said inventions; and we also concurrently hereby sell, assign and transfer to **VIA Technologies, Inc. of Taiwan, R.O.C.**, the entire right, title and interest in and to said inventions for all countries foreign to the United States, including all rights of priority arising from the application aforesaid, and all the rights and privileges under any and all forms of protection, including Letters Patent, that may be granted in said countries foreign to the United States for said inventions.

I/We authorize **VIA Technologies, Inc. of Taiwan, R.O.C.**, to make application for such protection in its own name and maintain such protection in any and all countries foreign to the United States, and to invoke and claim for any application for patent or other form of protection for said inventions, without further authorization from us, any and all benefits, including the right of priority provided by any and all treaties, conventions, or agreements.

I/We hereby consent that a copy of this assignment shall be deemed a full legal and formal equivalent of any document which may be required in any country in proof of the right of **VIA Technologies, Inc. of Taiwan, R.O.C.**, to apply for patent or other form of protection for said inventions and to claim the aforesaid benefit of the right of priority.

I/We request that any and all patents for said inventions be issued to **VIA Technologies, Inc. of Taiwan, R.O.C., Inc.**, in the United States and in all countries foreign to the United States, or to such nominees as **VIA Technologies, Inc. of Taiwan, R.O.C.**, may designate.

I/We agree that, when requested, I/we shall, without charge to VIA Technologies, Inc. of Taiwan, R.O.C., but at its expense, sign all papers, and do all acts which may be necessary, desirable or convenient in connection with said applications, patents, or other forms of protection.

Dated: 2/1/05

  
Sheng-Yuan Lee

Residence:

8F, No. 535, Chung-Cheng Road, Hsin-Tien, Taipei 231, Taiwan ROC

Citizenship: Taiwan ROC

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